

Medium current 1.2 to 37 V adjustable voltage regulator

Features

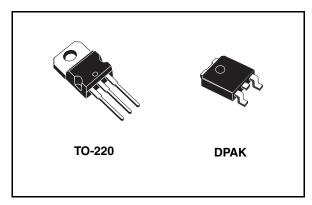
- Output voltage range: 1.2 to 37 V
- Output current in excess of 500 mA
- Line regulation typ. 0.01 %
- Load regulation typ. 0.1 %
- Thermal overload protection
- Short circuit protection
- Output transition safe area compensation
- Floating operation for high voltage applications

Description

The LM217M/LM317M are monolithic integrated circuits in TO-220 and DPAK packages intended for use as positive adjustable voltage regulators. They are designed to supply until 500 mA of load

current with an output voltage adjustable over a 1.2 to 37 V range.

The nominal output voltage is selected by means of only a resistive divider, making the device



exceptionally easy to use and eliminating the stocking of many fixed regulators.

Table 1. Device summary

Order codes		
TO-220 DPAK (tape and reel)		
	LM217MDT-TR	
LM317MT	LM317MDT-TR	

Contents LM217M - LM317M

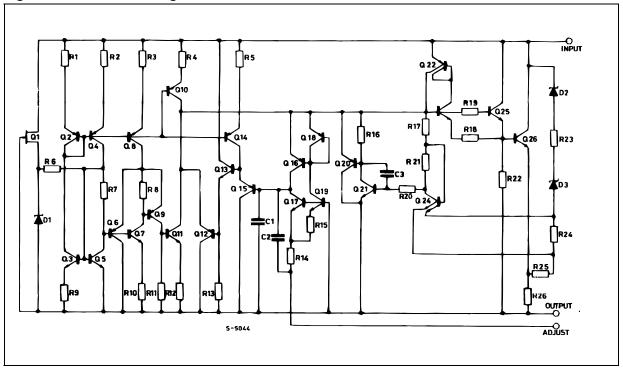
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LM217M - LM317M Diagram

1 Diagram

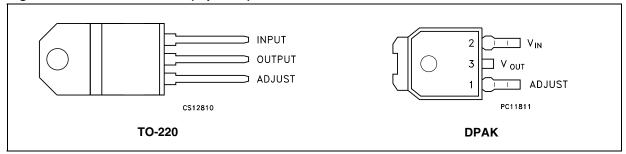
Figure 1. Schematic diagram



Pin configuration LM217M - LM317M

2 Pin configuration

Figure 2. Pin connections (top view)



LM217M - LM317M Maximum ratings

3 Maximum ratings

Table 2. Absolute maximum ratings

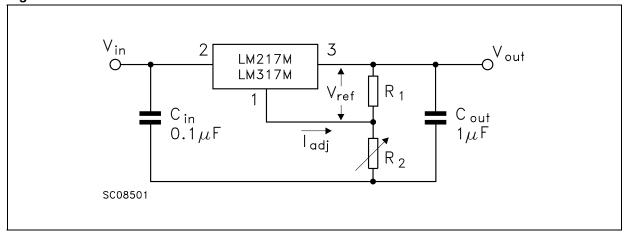
Symbol	Parameter	Value	Unit	
V _I -V _O	Input-output differential voltage	40	V	
P _D	Power dissipation	Internally limited	mW	
_	Operating junction temperature range (1)	for LM217M	-40 to 125	°C
T _{OP}	Operating junction temperature range (1) for LM317M		0 to 125	
T _{STG}	Storage temperature range	-55 to 150	°C	

^{1.} Re-Boot is not guaranteed for $T_J \ge 85^{\circ}C$.

Table 3. Thermal data

Symbol	Parameter	TO-220	DPAK	Unit
R _{thJC}	Thermal resistance junction-case	3	8	°C/W
R _{thJA}	Thermal resistance junction-ambient	50	100	°C/W

Figure 3. Test circuit



Electrical characteristics LM217M - LM317M

4 Electrical characteristics

Table 4. Electrical characteristics of LM217M (refer to the test circuits, T_J = - 40 to 125 °C, V_I - V_O = 5 V, I_O = 100 mA, P_D ≤7.5 W, unless otherwise specified)

Symbol	Parameter	Test co	onditions	Min.	Тур.	Max.	Unit	
41/	Line regulation	$V_1 - V_0 = 3 \text{ to } 40 \text{ V}$	$T_J = 25^{\circ}C$		0.01	0.02	%/V	
ΔV_{O}	ΔV _O Line regulation	$V_1 - V_0 = 3.10.40 \text{ V}$			0.02	0.05	70/ V	
		V _O ≤5 V	$T_J = 25^{\circ}C$		5	15	mV	
41/	Load regulation	$I_{O} = 10 \text{ to } 500 \text{mA}$			20	50	IIIV	
ΔV_{O}	Load regulation	V _O ≥ 5 V	$T_J = 25^{\circ}C$		0.1	0.3	9/ /\/	
		$I_{O} = 10 \text{ to } 500 \text{mA}$			0.3	1	%/V _O	
I _{ADJ}	Adjustment pin current			50	100	μΑ		
ΔI_{ADJ}	Adjustment pin current	$V_I - V_O = 3 \text{ to } 40 \text{ V},$	I _O = 10 to 500 mA		0.2	5	μA	
V _{REF}	Reference voltage	$V_I - V_O = 3 \text{ to } 40 \text{ V},$	I _O = 10 to 500 mA	1.2	1.25	1.3	V	
$\Delta V_{O}/V_{O}$	Output voltage temperature stability				0.7		%	
I _{O(min)}	Minimum load current	V _I - V _O = 40 V			3.5	5	mA	
1	Maximum autout aurrant	V _I - V _O ≤15 V		500	1000		m A	
I _{O(max)}	Maximum output current	$V_{I} - V_{O} = 40 \text{ V}, P_{d} < P_{DMAX}, T_{J} = 25^{\circ}\text{C}$			200		- mA	
eN	Output noise voltage (percentage of V _O)	B = 10 Hz to 100 kH		0.003		%		
CVD	Supply voltage rejection (1)	T _J = 25°C	$C_{ADJ} = 0$		65		40	
SVR	Supply voltage rejection (1)	f = 120 Hz	C _{ADJ} = 10 μF	66	80	dB		

^{1.} C_{ADJ} is connected between Adjust pin and Ground.

Table 5.Electrical characteristics of LM317M (refer to the test circuits, $T_J = 0$ to 125 °C,
 $V_I - V_O = 5$ V, $I_O = 100$ mA, $P_D \le 7.5$ W, unless otherwise specified)

Symbol	Parameter	Test co	onditions	Min.	Тур.	Max.	Unit	
۸۱/	Line regulation	$V_1 - V_0 = 3 \text{ to } 40 \text{ V}$	$T_J = 25^{\circ}C$		0.01	0.04 %/V		
ΔV_{O}	Line regulation	$V_1 - V_0 = 3.10.40 \text{ V}$			0.02	0.07	70/ V	
		V _O ≤5 V	$T_J = 25^{\circ}C$		5	25	mV	
417	Load regulation	$I_{O} = 10 \text{ to } 500 \text{mA}$			20	70	IIIV	
ΔV _O	Load regulation	V _O ≥ 5 V	$T_J = 25^{\circ}C$		0.1	0.5	o/ // /_	
		I _O = 10 to 500mA			0.3	1.5	%/V _O	
I _{ADJ}	Adjustment pin current			50	100	μA		
ΔI_{ADJ}	Adjustment pin current	$V_1 - V_0 = 3 \text{ to } 40 \text{ V},$	I _O = 10 to 500 mA		0.2	5	μA	
V _{REF}	Reference voltage	$V_I - V_O = 3 \text{ to } 40 \text{ V},$	I _O = 10 to 500 mA	1.2	1.25	1.3	V	
$\Delta V_{O}/V_{O}$	Output voltage temperature stability				0.7		%	
I _{O(min)}	Minimum load current	V _I - V _O = 40 V			3.5	10	mA	
1	Maximum output ourrant	V _I - V _O ≤15 V		500	1000		A	
I _{O(max)}	Maximum output current	$V_{I} - V_{O} = 40 \text{ V}, P_{d} < P_{DMAX}, T_{J} = 25^{\circ}\text{C}$			200		mA	
eN	Output noise voltage (percentage of V _O)	B = 10 Hz to 100 kH		0.003		%		
CVD	Supply voltage rejection (1)	T _J = 25°C	C _{ADJ} = 0		65		dB	
SVR	Supply voltage rejection (1)	f = 120 Hz	C _{ADJ} = 10 μF	66	80			

^{1.} C_{ADJ} is connected between Adjust pin and Ground.

5 Typical performance

Figure 4. Current limit

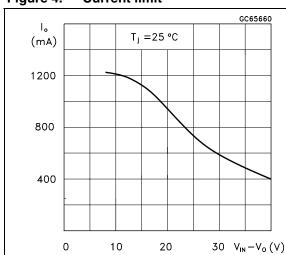


Figure 5. Minimum operating current

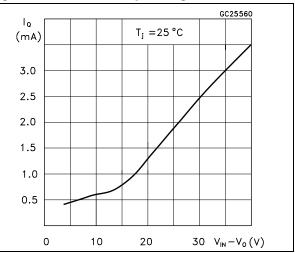


Figure 6. Basic adjustable regulator

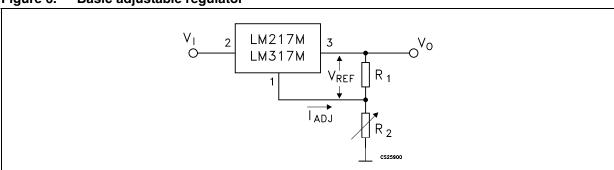
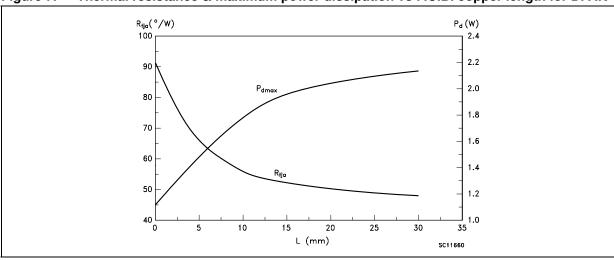


Figure 7. Thermal resistance & maximum power dissipation vs P.C.B. copper length for DPAK



Note: F

 P_{dmax} calculated for $T_a = 50$ °C.

6 Application information

The LM217M/LM317M provide an internal reference voltage of 1.25 V between the output and adjustment terminals. These devices are used to set a constant current flow across an external resistor divider (see *Figure 6*), giving an output voltage V_O of: $V_O = V_{REF} (1 + R_2 / R_1) + I_{AD,I} R_2$

The devices were designed to minimize the term I_{ADJ} (100 μA max) and to maintain it very constant in line and load changes. Usually, the error term $I_{ADJ} \times R_2$ can be neglected. To obtain the previous requirement, all the regulator quiescent current is returned to the output terminal, imposing a minimum load current condition. If the load is insufficient, the output voltage will rise.

Since the LM217M/LM317M devices are floating regulators and "see" only the input-to-output differential voltage, supplies of very high voltage with respect to ground can be regulated as long as the maximum input-to-output differential is not exceeded. Furthermore, programmable regulators are easily obtained and, by connecting a fixed resistor between the adjustment and output, the devices can be used as a precision current regulator. In order to optimize the load regulation, the current set resistor R_1 (see *Figure 6*) should be tied as close as possible to the regulator, while the ground terminal of R_2 should be near the ground of the load to provide remote ground sensing.

6.1 External capacitors (Figure 8)

Normally no capacitors are needed unless the devices are situated far from the input filter capacitors; in which case an input bypass is needed.

A 0.1 μ F disc or 1 μ F tantalum input bypass capacitor (C_I) is recommended to reduce the sensitivity to input line impedance.

The adjustment terminal may be bypassed to ground to improve ripple rejection. This capacitor (C_{ADJ}) prevents ripple from being amplified as the output voltage is increased. A 10 μ F capacitor should improve ripple rejection of about 80 dB at 120 Hz in a 10 V application.

Although the LM217M/LM317M devices are stable with no output capacitance like any feedback circuit, certain values of external capacitance can cause excessive ringing. An output capacitance (C_O) in the form of a 1 μ F tantalum or 25 μ F aluminium electrolytic capacitor on the output swamps this effect and insures stability.

6.2 Protection diodes (Figure 8)

When external capacitors are used with any IC regulator it is sometimes necessary to add protection diodes to prevent the capacitors from discharging through low current points into the regulator.

Figure 6 shows the LM217M/LM317M with the recommended protection diodes for output voltages in excess of 25 V or high capacitance values ($C_3 > 25 \mu F$, $C_2 > 10 \mu F$). Diode D1 prevents C_3 from discharging through the IC during an input short-circuit. The combination of diodes D1 and D2 prevents C_2 from discharging through the regulator during an input or output short-circuit.

6.3 Start-up block

It's not guaranteed the Re-Boot of the device when the junction temperature is over 85 °C.

Application circuits LM217M - LM317M

7 Application circuits

Figure 8. Voltage regulator with protection diodes

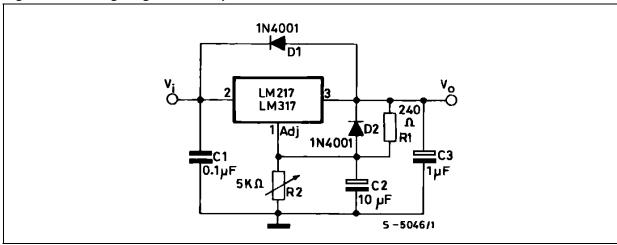


Figure 9. Slow turn-on 15 V regulator

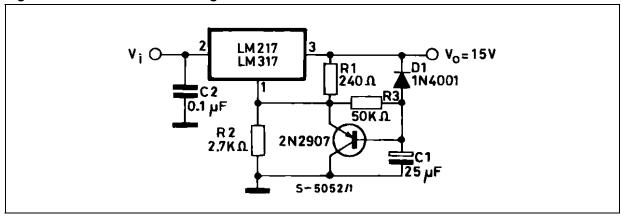
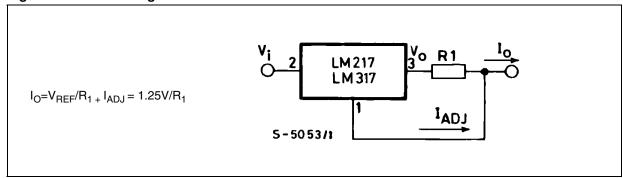


Figure 10. Current regulator



LM217M - LM317M Application circuits

Figure 11. 5 V electronic shut-down regulator

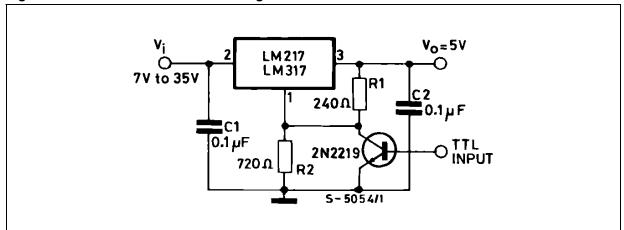
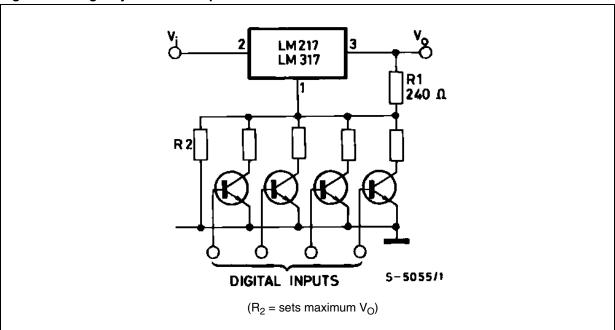


Figure 12. Digitally selected outputs

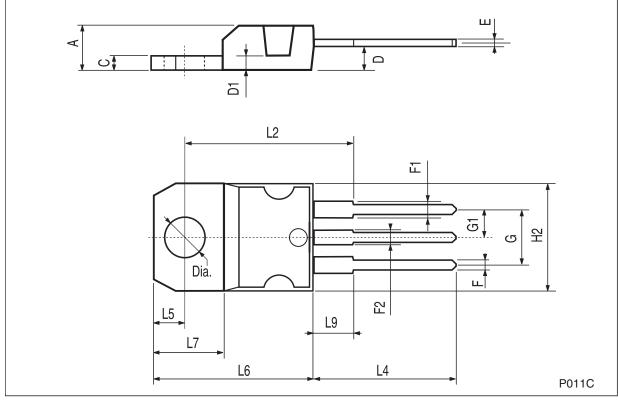


8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

TO-220 mechanical data

Dim		mm.			inch.	
Dim.	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.40		4.60	0.173		0.181
С	1.23		1.32	0.048		0.051
D	2.40		2.72	0.094		0.107
D1		1.27			0.050	
E	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.203
G1	2.4		2.7	0.094		0.106
H2	10.0		10.40	0.393		0.409
L2		16.4			0.645	
L4	13.0		14.0	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.2		6.6	0.244		0.260
L9	3.5		3.93	0.137		0.154
DIA.	3.75		3.85	0.147		0.151



"GATE" Note 6 THERMAL PAD c2 - E1 -L2 D1 Н L4 A 1 Note 7 b(2x)R – e 1-С SEATING PLANE A2 (L1) *V2* GAUGE PLANE 0,25 0068772/G

Figure 13. Drawing dimension DPAK (type STD-ST)

THERMAL PAD c2 E1-L2 D1 D Н A 1 <u>b</u> (2x) R - e - (2x)С SEATING PLANE A2 V2 GAUGE PLANE 0,51 0068772/G

Figure 14. Drawing dimension DPAK (type FUJITSU-Subcon.)

THERMAL PAD c2 - E1 *L2* D1 D L4 A 1 **b**(2x) — е 1— С SEATING PLANE *A2* L1 GAUGE PLANE 0,25 0068772/G

Figure 15. Drawing dimension DPAK (type IDS-Subcon.)

Table 6. DPAK mechanical data

	type STD-ST		type FUJITSU-Subcon.			type IDS-Subcon			
Dim.		mm.			mm.		mm.		
	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.20		2.40	2.25	2.30	2.35	2.19		2.38
A1	0.90		1.10	0.96		1.06	0.89		1.14
A2	0.03		0.23	0		0.10	0.03		0.23
b	0.64		0.90	0.76		0.86	0.64		0.88
b4	5.20		5.40	5.28		5.38	5.21		5.46
С	0.45		0.60	0.46		0.56	0.46		0.58
c2	0.48		0.60	0.46		0.56	0.46		0.58
D	6.00		6.20	6.05		6.15	5.97		6.22
D1		5.10		5.27		5.47		5.20	
Е	6.40		6.60	6.55	6.60	6.65	6.35		6.73
E1		4.70			4.77			4.70	
е		2.28		2.23	2.28	2.33		2.28	
e1	4.40		4.60				4.51		4.61
Н	9.35		10.10	9.90		10.30	9.40		10.42
L	1.00			1.40		1.60	0.90		
L1		2.80					2.50		2.65
L2		0.80		1.03		1.13	0.89		1.27
L4	0.60		1.00	0.70		0.90	0.64		1.02
R		0.20			0.40			0.20	
V2	0°		8°	0°		8°	0°		8°

Note: The DPAK package coming from the two subcontractors (Fujitsu and IDS) are fully compatible with the ST's package suggested footprint.

Figure 16. DPAK footprint recommended data

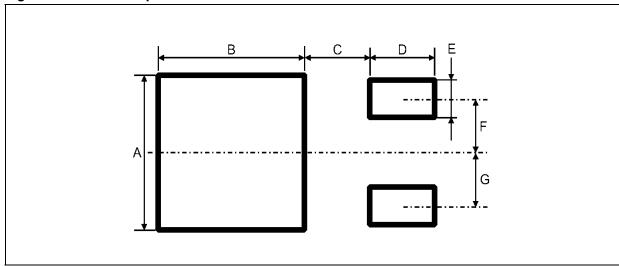
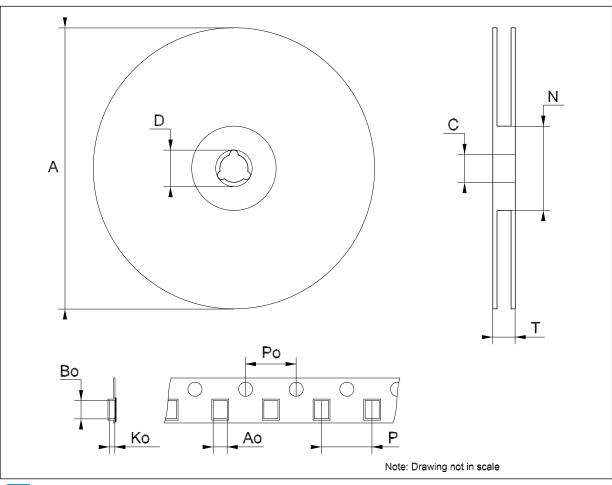


Table 7. Footprint data

Values					
Dim.	mm.	inch.			
А	6.70	0.264			
В	6.70	0.64			
С	1.8	0.070			
D	3.0	0.118			
E	1.60	0.063			
F	2.30	0.091			
G	2.30	0.091			

Tape & reel DP	AK-PPAK	mechanical	data
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Dim		mm.			inch.		
Dim.	Min.	Тур.	Max.	Min.	Тур.	Max.	
А			330			12.992	
С	12.8	13.0	13.2	0.504	0.512	0.519	
D	20.2			0.795			
N	60			2.362			
Т			22.4			0.882	
Ao	6.80	6.90	7.00	0.268	0.272	0.2.76	
Во	10.40	10.50	10.60	0.409	0.413	0.417	
Ko	2.55	2.65	2.75	0.100	0.104	0.105	
Po	3.9	4.0	4.1	0.153	0.157	0.161	
Р	7.9	8.0	8.1	0.311	0.315	0.319	



Revision history LM217M - LM317M

9 Revision history

Table 8. Document revision history

Date	Revision	Changes
21-Jun-2004	5	The document has been reformatted.
06-Dec-2006	6	DPAK mechanical data updated, added footprint data.
11-Feb-2008	7	Added: Table 1 on page 1.

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